

## 2SK4012

TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type ( $\pi$ -MOSVI)

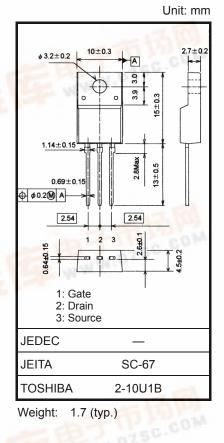
# 2SK4012

#### Switching Regulator Applications

- Low drain-source ON-resistance
- : R<sub>DS (ON)</sub> = 0. 33 Ω (typ.)
- High forward transfer admittance  $(Y_{fs}) = 8.5 \text{ S} (typ.)$
- Low leakage current :  $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 500 \ V)$
- Enhancement mode :  $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic MAN		Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	500	V
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	500	V
Gate-source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC (Note 1)	Ι <sub>D</sub>	13	А
	Pulse (Note 1)	I <sub>DP</sub>	52	Α
Drain power dissipation (Tc = 25°C)		PD	45	W
Single-pulse avalanche energy (Note 2)		E <sub>AS</sub>	1170	mJ
Avalanche current		I <sub>AR</sub>	13	А
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4.5	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55~150	°C



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

### Thermal Characteristics

Characteristic	Symbol	Мах	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.78	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$  (initial), L = 11.8 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AR</sub> = 13 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



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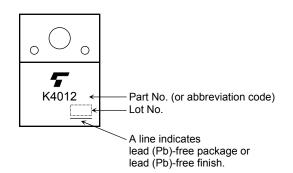
## Electrical Characteristics (Ta = 25°C)

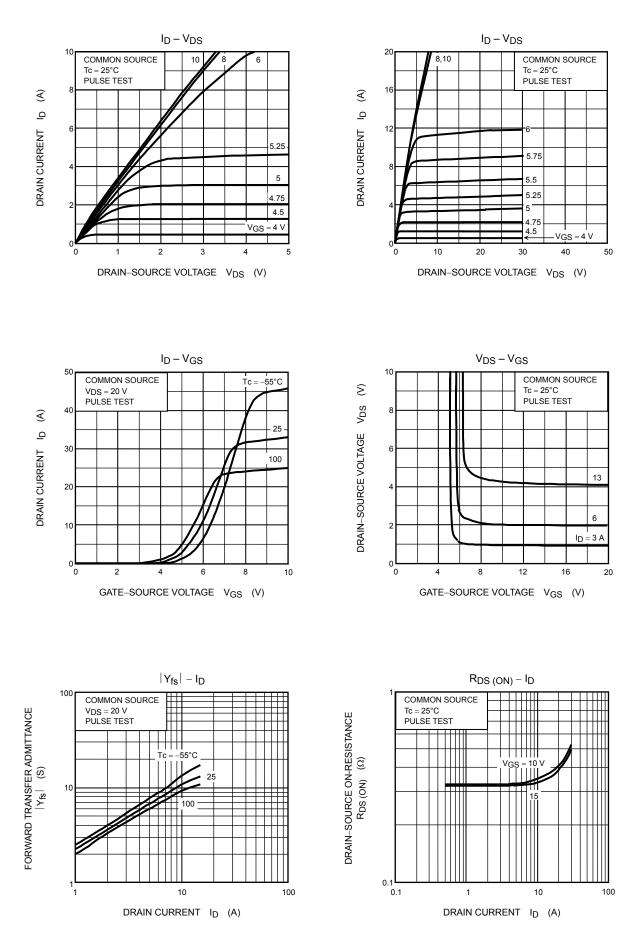
Chara	cteristic	Symbol	Test Condition	Min	Тур.	Мах	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS}$ = ±25 V, $V_{DS}$ = 0 V	_	_	±10	μA
Gate-source br	eakdown voltage	V <sub>(BR)</sub> GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cutoff curr	rent	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	100	μA
Drain-source br	reakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N-resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A		0.33	0.4	Ω
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A	4.0	8.5		S
Input capacitance	It capacitance C <sub>iss</sub>			2400	_		
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		18		pF
Output capacitance		C <sub>oss</sub>			220		
Switching time	Rise time	tr	$\begin{array}{c} 10 \text{ V} \\ \text{V}_{GS} \\ 0 \text{ V} \\ 15 \Omega \\ \text{W}_{DD} \approx 200 \text{ V} \\ \text{Duty} \leq 1\%, t_{W} = 10 \ \mu\text{s} \end{array}$	_	25	_	- ns
	Turn-on time	t <sub>on</sub>		_	70	_	
	Fall time	t <sub>f</sub>		_	10	_	
	Turn-off time	t <sub>off</sub>			95		
Total gate charge (gate-source plus gate-drain)		Qg		_	50	_	
Gate-source charge		Q <sub>gs</sub>	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13 A	_	30	_	nC
Gate-drain ("Miller") charge		Q <sub>gd</sub>	]		20		

## Source–Drain Ratings and Characteristics (Ta = 25°C)

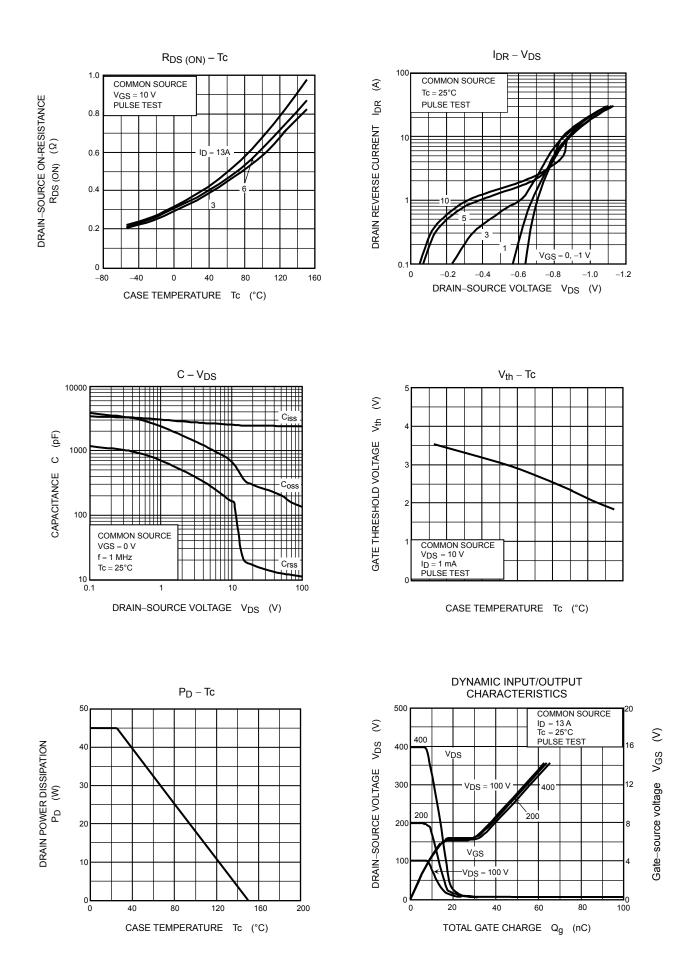
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	_	13	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	_		52	А
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V		1000		ns
Reverse recovery charge	Qrr	dI <sub>DR</sub> / dt = 100 A / μs		11		μC

## Marking

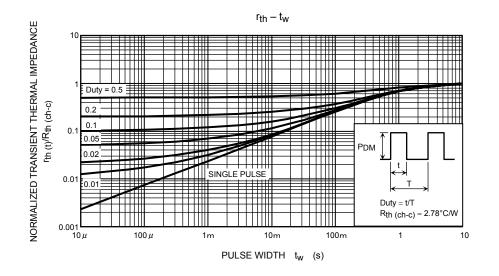




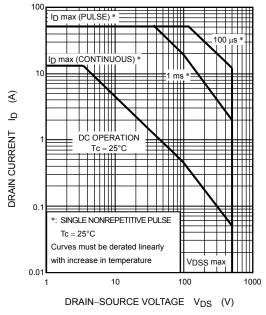
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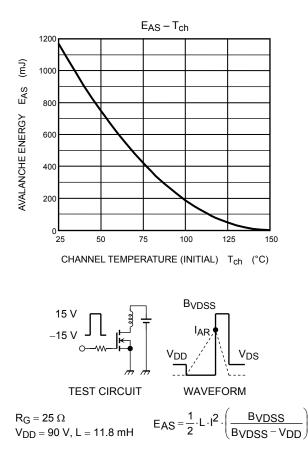


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SAFE OPERATING AREA





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Handbook" etc.

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